

## High Speed Switching Diode

### Features

- Small Surface Mounting Type
- High Speed
- High Reliability With High Surge Current Handling Capability
- Lead free in comply with EU RoHS 2011/65/EU directives



### Mechanical Data

- Package: SOD-523
- Polarity: Color band denotes cathode end
- Epoxy UL: 94V-0
- Mounting Position: Any

### Ordering Information

Part Number	Marking	Shipping	Reel
LT5L0210X-TR3	A	3000PCS Tape&Reel	7 inches
LT5L0210X-TR10	A	10000PCS Tape&Reel	7 inches

### Absolute Maximum Rating (Ta=25°C unless otherwise noted)

Parameters	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V <sub>RM</sub>	90	V
DC Blocking Voltage	V <sub>R</sub>	80	V
Average Rectified Output Current	I <sub>o</sub>	100	mA
Forward Continuous Current	I <sub>FM</sub>	225	mA
Non-repetitive Peak Forward Surge Current@t= 8.3ms	I <sub>FSM</sub>	2.0	A
Power Dissipation	P <sub>d</sub>	150	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature range	T <sub>STG</sub>	-55-+150	°C

### Electrical Characteristics (Ta=25°C unless otherwise specified)

Symbols	Parameter	Test Condition	Limits		Unit
			Min	Max	
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> =100mA		1.2	V
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 80V		0.1	uA
T <sub>RR</sub>	Reverse Recovery Time	V <sub>R</sub> = 6V,		4	nS
		I <sub>F</sub> = 10mA,			
		R <sub>L</sub> =100Ω,			
C	Capacitance	V <sub>R</sub> =0.5V, f=1MHZ		3	pF



### Characteristics Curve

Fig.1 Forward characteristics

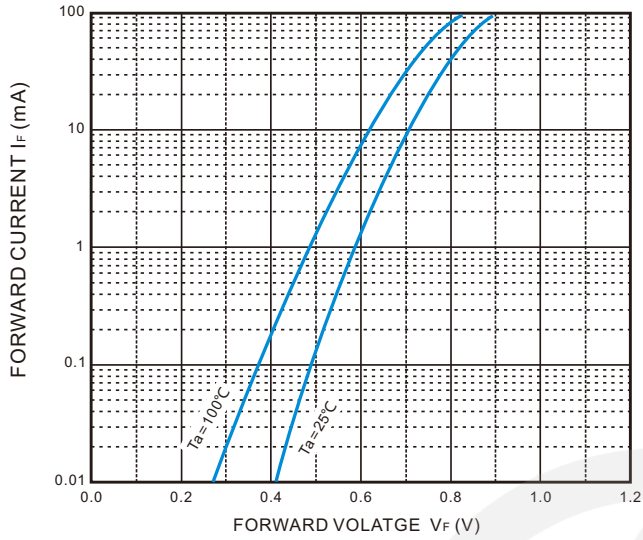


Fig.2 Reverse characteristics

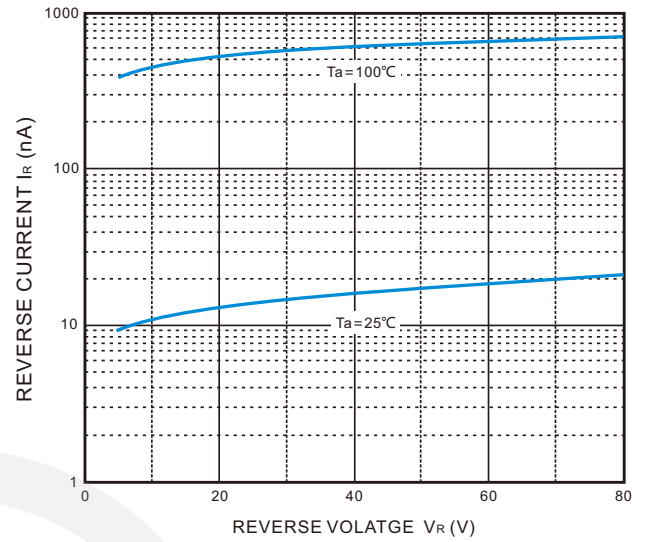


Fig.3 Capacitance characteristics

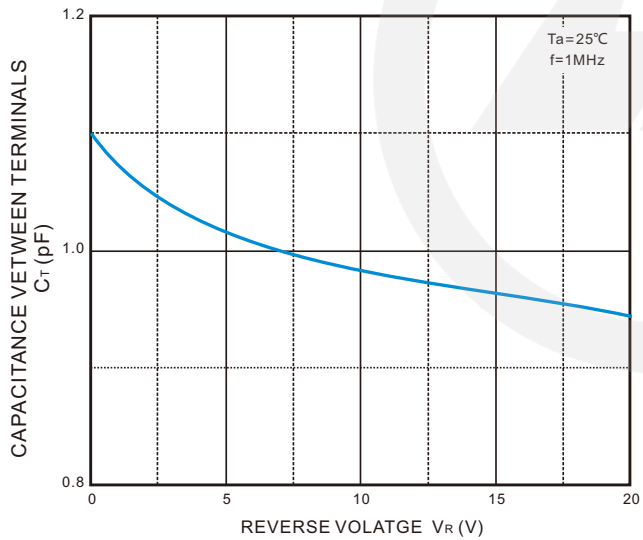
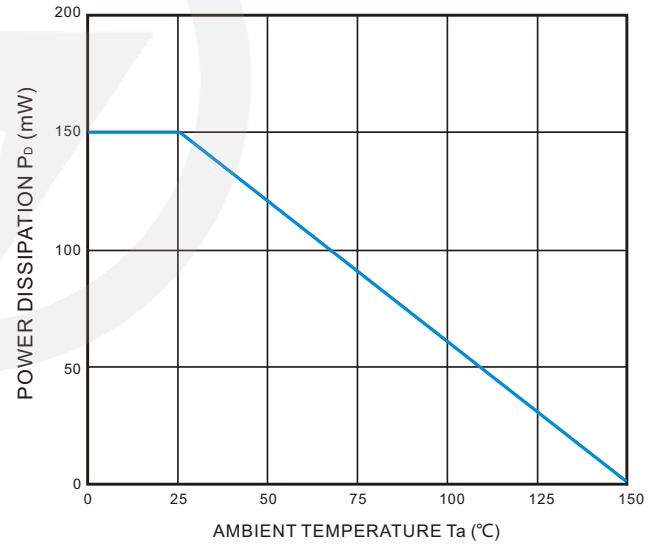
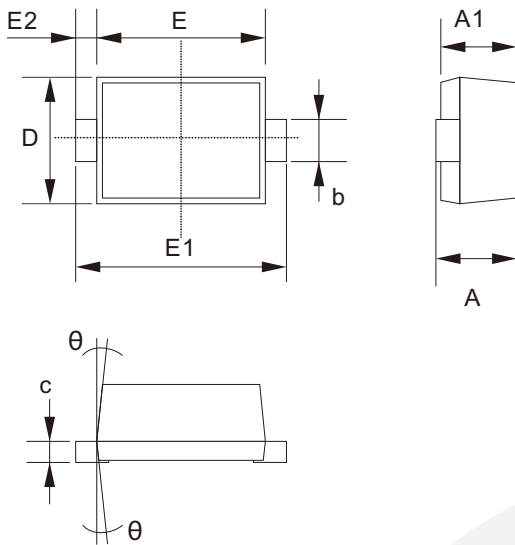


Fig.4 Power Derating Curve



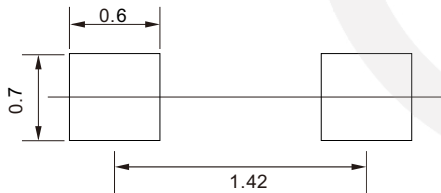
**SOD-523 Package Outline**

Unit: mm



SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.500	0.770
A1	0.500	0.700
b	0.250	0.380
c	0.070	0.200
D	0.700	0.900
E	1.100	1.300
E1	1.500	1.700
E2	0.200 REF	
θ	7° REF	

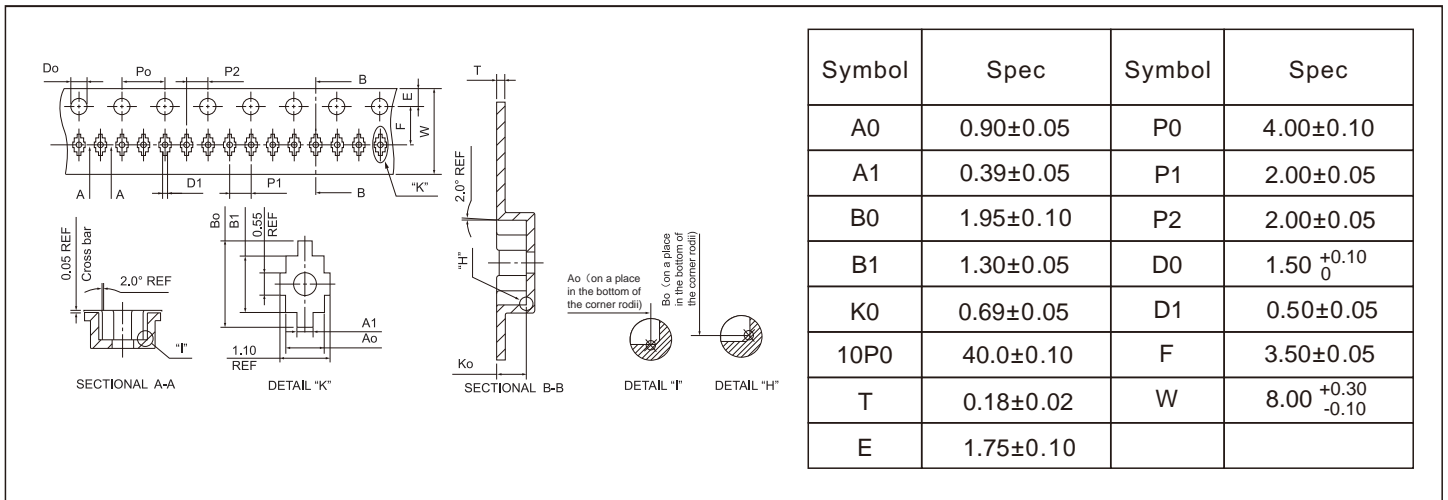
**SOD-523 Suggested Pad Layout**



- Note:
1. Controlling dimension: in millimeters.
  2. General tolerance:  $\pm 0.05$  mm.
  3. The pad layout is for reference purposes only.

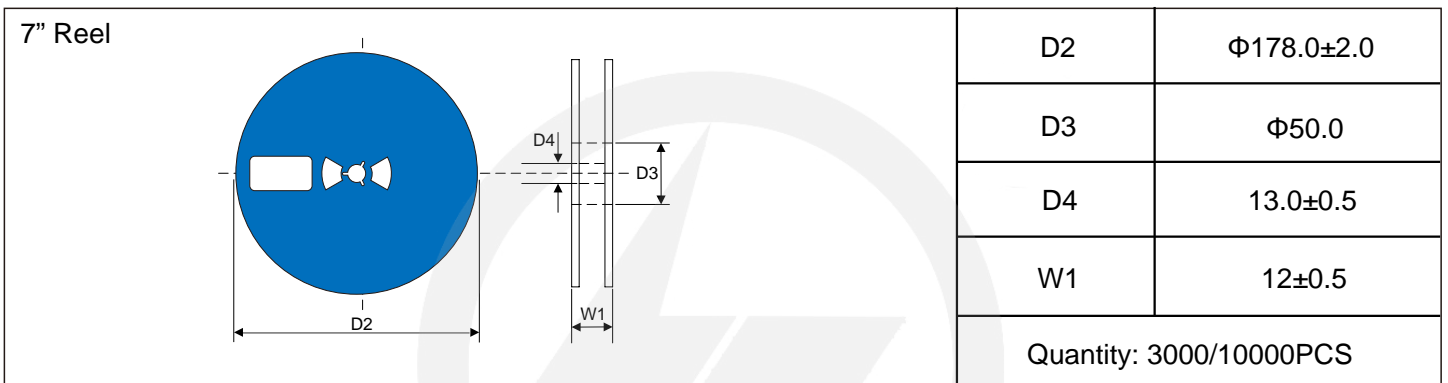
## Carrier Tape Dimensions

Unit : mm

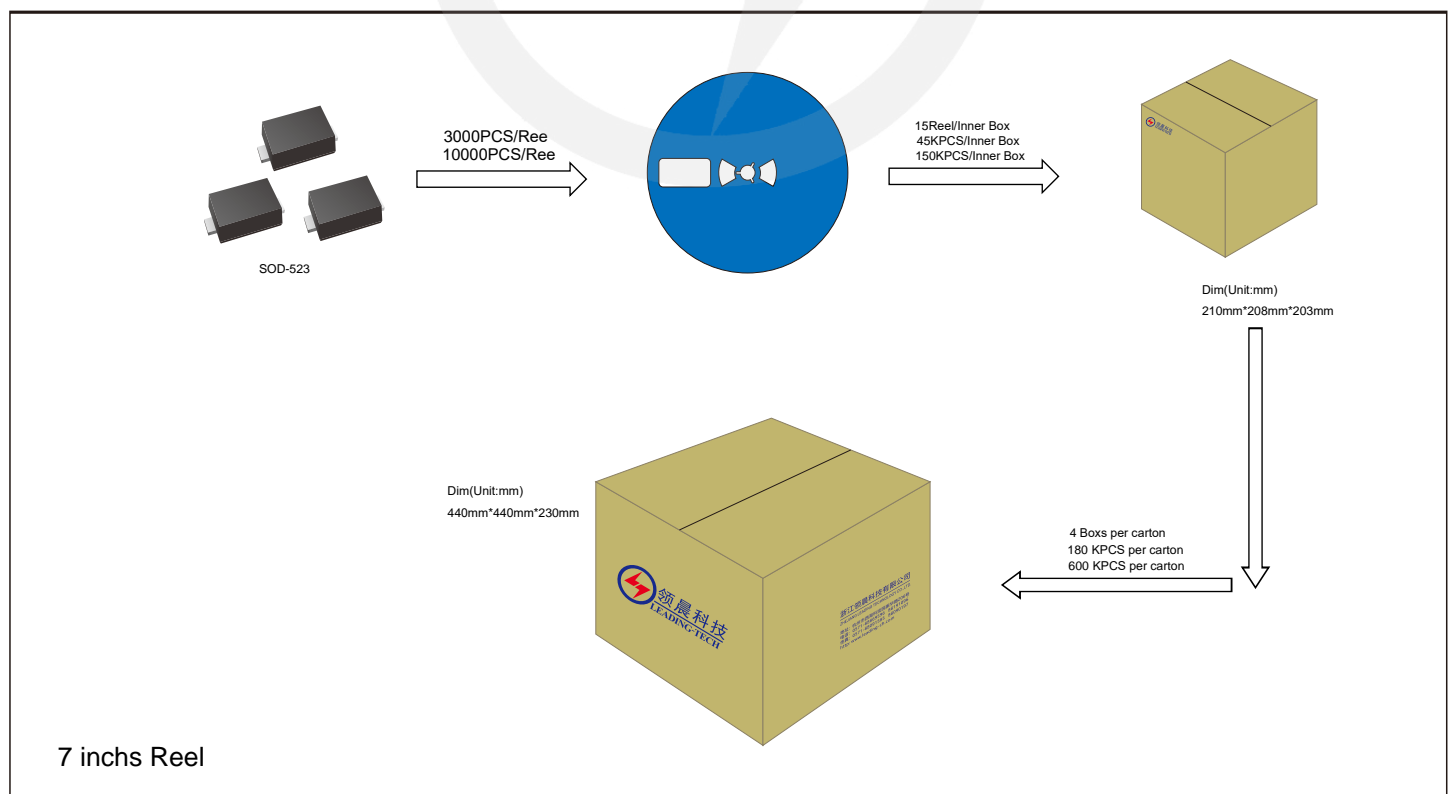


## Reel Dimensions

Unit : mm

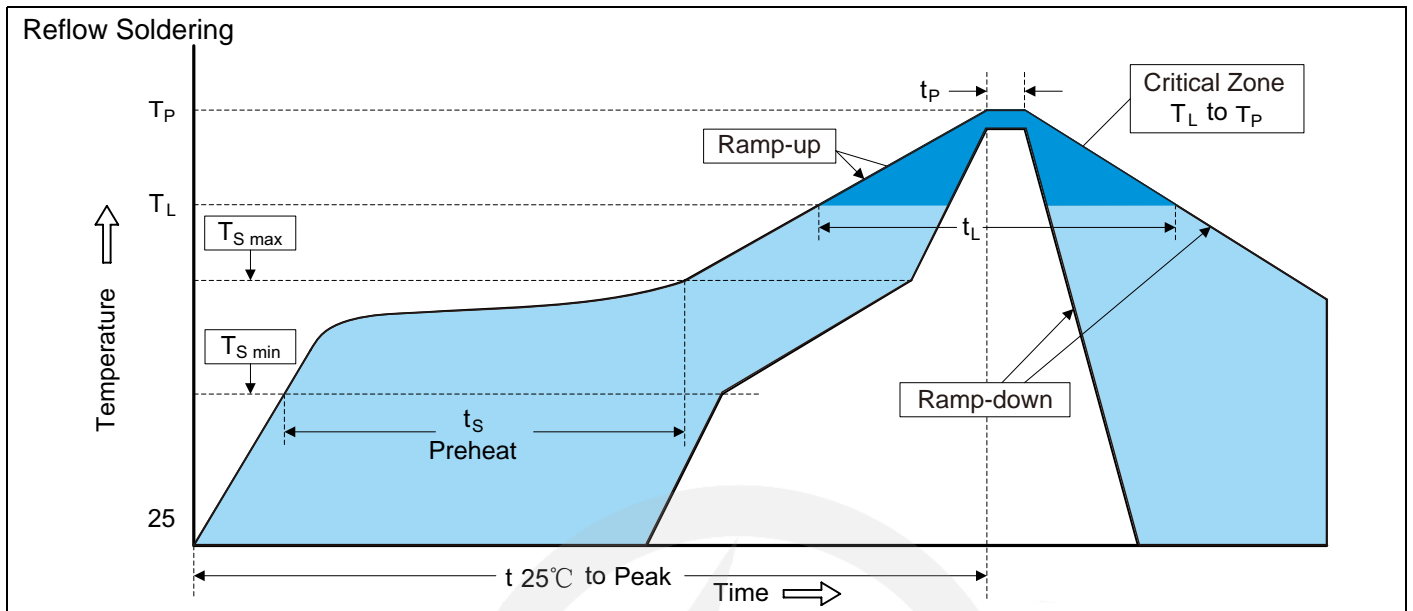


## Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/second max.
Preheat	
-Temperature Min (T <sub>S min</sub> )	150°C
-Temperature Max (T <sub>S max</sub> )	200°C
-Time (min to max) (t <sub>s</sub> )	60-180 seconds
T <sub>S max</sub> to T <sub>L</sub>	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T <sub>L</sub> )	217°C
-Time (t <sub>L</sub> )	60-150 seconds
Peak Temperature (T <sub>P</sub> )	260°C
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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## Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.10.10	2024.10.10	3.0	New File	/	Ding	